



Model 74660 Model 73660



General Information

Models 72660, 73660 and 74660 are members of the Cobalt® family of high performance CompactPCI boards based on the Xilinx Virtex-6 FPGA. They consist of one or two Model 71660 XMC modules mounted on a cPCI carrier board.

Model 72660 is a 6U cPCI board while the Model 73660 is a 3U cPCI board; both are equipped with one Model 71660 XMC. Model 74660 is a 6U cPCI board with two XMC modules rather than one.

These models include four or eight A/Ds and four or eight banks of memory.

The Cobalt Architecture

The Pentek Cobalt Architecture features Virtex-6 FPGAs. All of the board's data and control paths are accessible by the FPGA, enabling factory-installed functions including data multiplexing, channel selection, data packing, gating, triggering and memory control. The Cobalt Architecture organizes the FPGA as a container for data processing applications where each function exists as an intellectual property (IP) module. Each member of the Cobalt family is delivered with factory-installed applications ideally matched to the board's analog interfaces. The factory-installed functions of these models include four or eight A/D acquisition IP modules.

IP modules for either DDR3 or QDRII+ memories, controllers for all data clocking and synchronization functions, a test signal

generator, and a PCIe interface complete the factory-installed functions and enable these models to operate as complete turnkey solutions without the need to develop FPGA IP.

Extendable IP Design

For applications that require specialized function, users can install their own custom IP for data processing. Pentek GateFlow FPGA Design Kits include all of the factory-installed modules as documented source code. Developers can integrate their own IP with the Pentek factory-installed functions or use the GateFlow kit to completely replace the Pentek IP with their own.

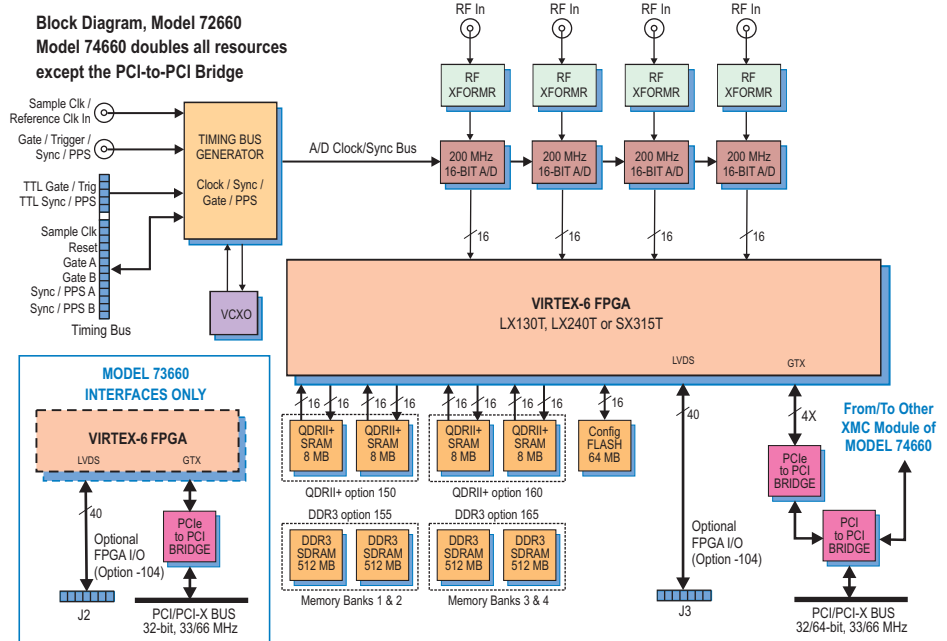
Xilinx Virtex-6 FPGA

The Virtex-6 FPGA site can be populated with a variety of different FPGAs to match the specific requirements of the processing task. Supported FPGAs include: LX130T, LX240T, or SX315T. The SXT part features 1344 DSP48E slices and is ideal for modulation/demodulation, encoding/decoding, encryption/decryption, and channelization of the signals between transmission and reception. For applications not requiring large DSP resources, one of the lower-cost LXT FPGAs can be installed.

Option -104 provides 20 LVDS pairs between the FPGA and the J2 connector, Model 73660; J3 connector, Model 72660; J3 and J5 connectors, Model 74660. ➤

Features

- Complete radar and software radio interface solution
- Supports Xilinx Virtex-6 LXT and SXT FPGAs
- Four or eight 200 MHz 16-bit A/Ds
- Up to 2 or 4 GB of DDR3 SDRAM; or: 32 or 64 MB of QDRII+ SRAM
- Sample clock synchronization to an external system reference
- LVPECL clock/sync bus for multiboard synchronization
- Optional LVDS connections to the Virtex-6 FPGA for custom I/O



► A/D Converter Stage

The front end accepts four or eight full-scale analog HF or IF inputs on front panel SSMC connectors at +8 dBm into 50 ohms with transformer coupling into four or eight Texas Instruments ADS5485 200 MHz, 16-bit A/D converters.

The digital outputs are delivered into the Virtex-6 FPGA for signal processing, data capture or for routing to other board resources.

Clocking and Synchronization

An internal timing bus provides all timing and synchronization required by the A/D converters. It includes a clock, two sync and two gate or trigger signals. An on-board clock generator receives an external sample clock from the front panel SSMC connector. This clock can be used directly by the A/D or divided by a built-in clock synthesizer circuit. In an alternate mode, the sample clock can be sourced from an on-board programmable voltage-controlled crystal oscillator. In this mode, the front panel SSMC connector can be used to provide a 10 MHz reference clock for synchronizing the internal oscillator.

A front panel 26-pin LVPECL Clock/Sync connector allows multiple boards to be synchronized. In the slave mode, it accepts LVPECL inputs that drive the clock, sync and gate signals. In the master mode, the

LVPECL bus can drive the timing signals for synchronizing multiple boards.

Multiple boards can be driven from the LVPECL bus master, supporting synchronous sampling and sync functions across all connected boards.

Memory Resources

The Cobalt architecture supports up to four or eight independent memory banks which can be configured with all QDRII+ SRAM, DDR3 SDRAM, or as combination of two banks of each type of memory.

Each QDRII+ SRAM bank can be up to 8 MB deep and is an integral part of the board's DMA capabilities, providing FIFO memory space for creating DMA packets. For applications requiring deeper memory resources, DDR3 SDRAM banks can each be up to 512 MB deep. Built-in memory functions include multichannel A/D data capture, tagging and streaming.

In addition to the factory-installed functions, custom user-installed IP within the FPGA can take advantage of the memories for many other purposes.

PCI-X Interface

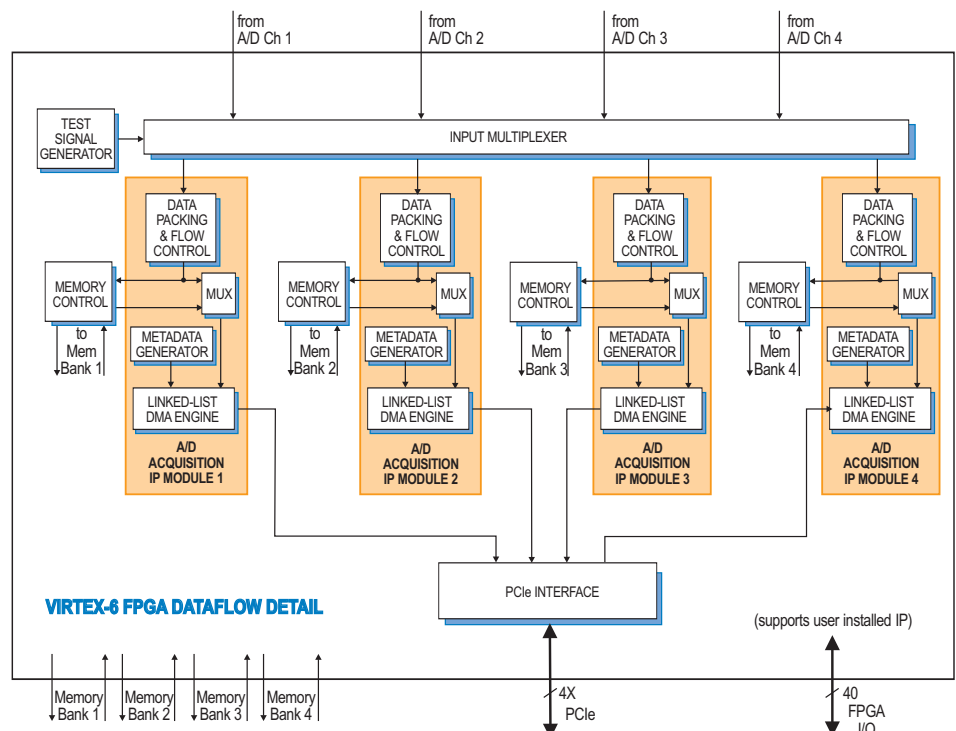
These models include an industry-standard interface fully compliant with PCI-X bus specifications. The interface includes multiple DMA controllers for efficient transfers to and from the board. Data widths of 32 or 64 bits and data rates of 33 and 66 MHz are supported. Model 73660: 32 bits only. ►

A/D Acquisition IP Modules

These models feature four or eight A/D Acquisition IP Modules for easily capturing and moving data. Each IP module can receive data from any of four A/Ds or a test signal generator

Each IP module has an associated memory bank for buffering data in FIFO mode or for storing data in transient capture mode. All memory banks are supported with DMA engines for easily moving A/D data through the PCIe interface. These powerful linked-list DMA engines are capable of a unique Acquisition Gate Driven mode. In this mode, the length of a transfer performed by a link definition need not be known prior to data acquisition; rather, it is governed by the length of the acquisition gate. This is extremely useful in applications where an external gate drives acquisition and the exact length of that gate is not known or is likely to vary.

For each transfer, the DMA engine can automatically construct metadata packets containing A/D channel ID, a sample-accurate time stamp and data length information. These actions simplify the host processor's job of identifying and executing on the data.



► Specifications

Model 72660 or Model 73660: 4 A/Ds

Model 74660: 8 A/Ds

Front Panel Analog Signal Inputs (4 or 8)

Input Type: Transformer-coupled, front panel female SSMC connectors

Transformer Type: Coil Craft WBC4-6TLB

Full Scale Input: +8 dBm into 50 ohms

3 dB Passband: 300 kHz to 700 MHz

A/D Converters (4 or 8)

Type: Texas Instruments ADS5485

Sampling Rate: 10 MHz to 200 MHz

Resolution: 16 bits

Sample Clock Sources (1 or 2)

On-board clock synthesizers

Clock Synthesizers (1 or 2)

Clock Source: Selectable from on-board programmable VCXO (10 to 810 MHz), front panel external clock or LVPECL timing bus

Synchronization: VCXO can be locked to an external 4 to 180 MHz PLL system reference, typically 10 MHz

Clock Dividers: External clock or VCXO can be divided by 1, 2, 4, 8, or 16 for the A/D clock

External Clocks (1 or 2)

Type: Front panel female SSMC connector, sine wave, 0 to +10 dBm, AC-coupled, 50 ohms, accepts 10 to 800 MHz divider input clock or PLL system reference

Timing Bus (1 or 2): 26-pin front panel connector; LVPECL bus includes, clock/sync/gate/PPS inputs and outputs; TTL signal for gate/trigger and sync/PPS inputs

External Trigger Inputs (1 or 2)

Type: Front panel female SSMC connector, LVTTTL

Function: Programmable functions include: trigger, gate, sync and PPS

Field Programmable Gate Arrays (1 or 2)

Standard: Xilinx Virtex-6 XC6VLX130T

Optional: Xilinx Virtex-6 XC6VLX240T or XC6VSX315T

Custom I/O

Option -104 provides 20 LVDS pairs between the FPGA and the J2 connector, Model 73660; J3 connector, Model 72660; J3 and J5 connectors, Model 74660

Memory Banks (1 or 2)

Option 150 or 160: Two 8 MB QDRII+ SRAM memory banks, 400 MHz DDR

Option 155 or 165: Two 512 MB DDR3 SDRAM memory banks, 400 MHz DDR

PCI-X Interface

PCI-X Bus: 32 or 64 bits at 33 or 66 MHz
Model 73660: 32 bits only

Environmental

Operating Temp: 0° to 50° C

Storage Temp: -20° to 90° C

Relative Humidity: 0 to 95%, non-cond.

Size: Standard 6U or 3U cPCI board

Ordering Information

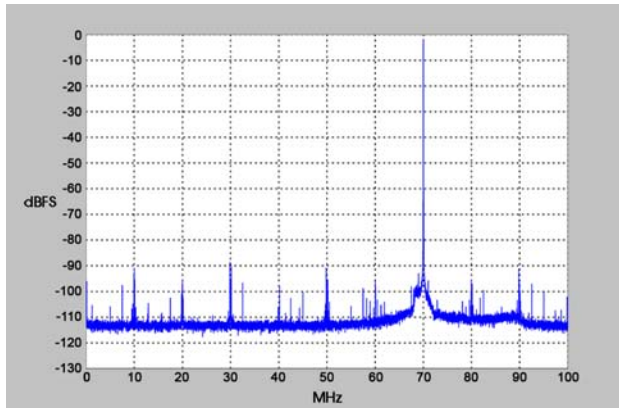
Model	Description
72660	4-Channel 200 MHz 16-bit A/D with Virtex-6 FPGA - 6U cPCI
73660	4-Channel 200 MHz 16-bit A/D with Virtex-6 FPGA - 3U cPCI
74660	8-Channel 200 MHz 16-bit A/D with two Virtex-6 FPGAs - 6U cPCI

Options:

-062	XC6VLX240T FPGA
-064	XC6VSX315T FPGA
-104	LVDS I/O between the FPGA and J2 connector, Model 73660; J3 connector, Model 72660; J3 and J5 connectors, Model 74660
-150	Two 8 MB QDRII+ SRAM Memory Banks (Banks 1 and 2)
-160	Two 8 MB QDRII+ SRAM Memory Banks (Banks 3 and 4)
-155	Two 512 MB DDR3 SDRAM Memory Banks (Banks 1 and 2)
-165	Two 512 MB DDR3 SDRAM Memory Banks (Banks 3 and 4)

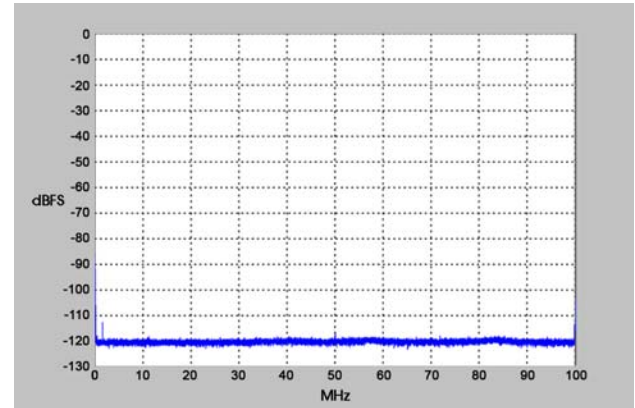
A/D Performance

Spurious Free Dynamic Range



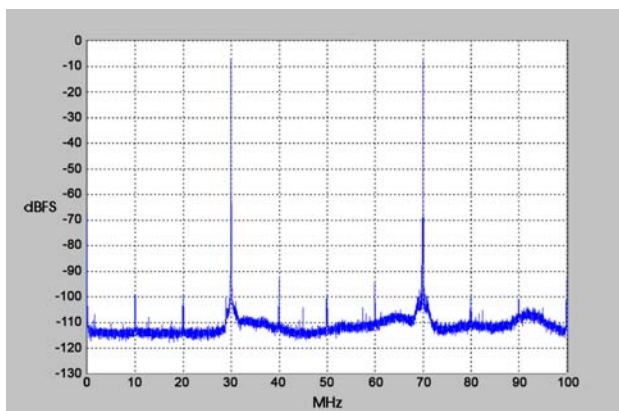
$f_{in} = 70 \text{ MHz}$, $f_s = 200 \text{ MHz}$, Internal Clock

Spurious Pick-up



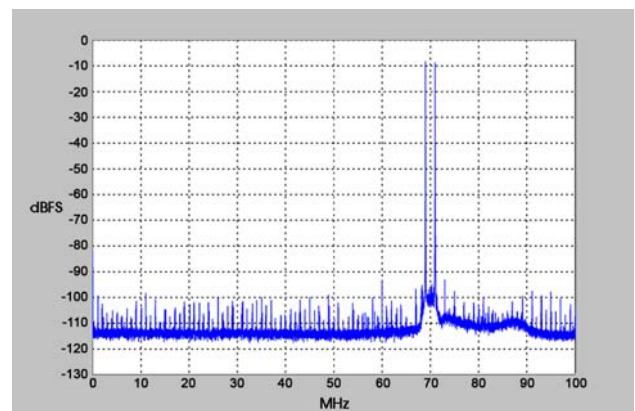
$f_s = 200 \text{ MHz}$, Internal Clock

Two-Tone SFDR



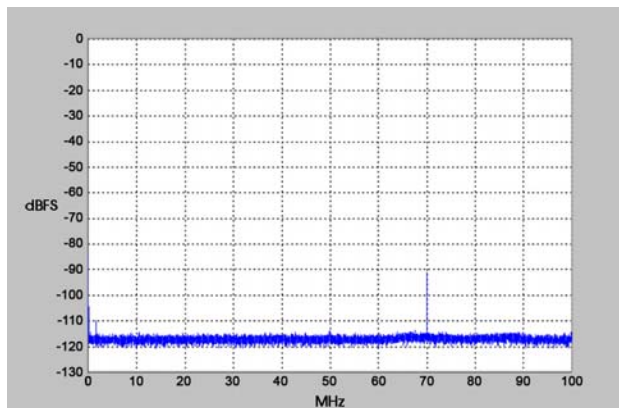
$f_1 = 30 \text{ MHz}$, $f_2 = 70 \text{ MHz}$, $f_s = 200 \text{ MHz}$

Two-Tone SFDR



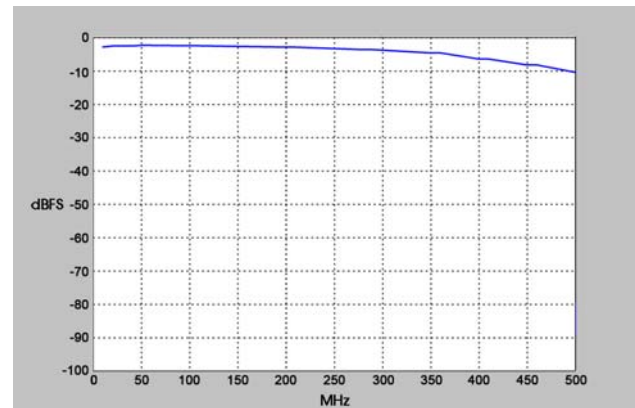
$f_1 = 69 \text{ MHz}$, $f_2 = 71 \text{ MHz}$, $f_s = 200 \text{ MHz}$

Adjacent Channel Crosstalk



$f_{in \text{ Ch2}} = 70 \text{ MHz}$, $f_s = 200 \text{ MHz}$, Ch 1 shown

Input Frequency Response



$f_s = 200 \text{ MHz}$, Internal Clock